

April 2, 2009

Obsolescence Notification No: 2758

Subject: Obsolescence of Multi Chip Package (MCP) Ordering Part Numbers (OPNs), built

with 16Mb pSRAM, Type 7

Spansion LLC is announcing the obsolescence of type 7, 16Mb pSRAM, and all valid combinations of the Multi-Chip Packages (MCPs) products listed below:

Product Identification: S71GL032NA0BFW0U0

S71GL032NA0BFW0Z0 S71GL064NA0BFW0U0 S71GL064NA0BFW0U3 S71GL064NA0BFW0Z0 S71GL064NA0BFW0Z2

Package Types: TSC056

Product Line: WSD - Wireless Solutions Division

Description of Obsolescence: Obsolescence of the MCP Ordering Part Numbers (OPNs) listed, built

with 16Mb pSRAM, Type 7.

Reason for Obsolescence: These products are being removed from Spansion's portfolio due to

commercial die used in the MCPs being end-of-life by the commercial

die supplier as a preventive action.

Application Impact: Consolidation of product offerings.

Replacement Parts: S71GL032NA0BFW0U -> S71GL032NA0BHW0B

Obsolescence No. 2758

04/06/09



S71GL032NA0BFW0Z -> S71GL032NA0BHW0F S71GL064NA0BFW0U -> S71GL064NA0BHW0B S71GL064NA0BFW0Z -> S71GL064NA0BHW0F

Last Order Date: October 2, 2009

Last Shipment Date: April 2, 2010

Products Affected By This Obsolescence (part numbers):

 S71GL032NA0BFW0U0
 S71GL032NA0BFW0Z0

 S71GL064NA0BFW0U0
 S71GL064NA0BFW0U3

 S71GL064NA0BFW0Z0
 S71GL064NA0BFW0Z2

The date projections above were based on the most current product development status at the time this ACN was issued, but are subject to change. For the latest schedule or additional information, please contact your local sales office or your local distributor.

Obsolescence No. 2758 04/06/09